Features

- Industry standard 1/2 brick package and footprint
  2.40"×2.28"×0.50"
- High power density: 90W/in3
- High efficiency: 90% typical
- 2:1 input voltage range
- Low output noise and ripple
- Remote sense
- Over-temperature protection
- Output over-current/voltage protection
- I.O.G. signal: open collector output
- Output voltage trim: +10% to -40%
- Baseplate operating temperature range: -40℃ to 100℃
- UL60950-1/ EN60950-1 Certified
- RoHS (2002/95/EC) complaint

Options:

- Sprayed Conformal Coating
- RoHS

Numbering Convention

HDR - L 100 2 S C –T- C G5
① ② ③ ④ ⑤⑥ ⑦ ⑧ ⑨

No	Features	Descriptions
①	Product Series	1/2 brick Al-Baseplate Series
②	Remote on/off Logic	L - Negative Logic
		H or Default - Positive Logic
③	Typical Output Power	100 - Output Power:100W
④	Typical Output Voltage	12 - Output Voltage: 12V
⑤	Number of Outputs	S - Single Output
⑥	Typical Input Voltage	C - Input Voltage: 48V
⑦	Model Number suffix	T - Output voltage trim
⑧	Sprayed Conformal Coating	C - Sprayed Conformal coating
		Default: no Sprayed Conformal coating
⑨	RoHS feature	G5 – RoHS5
		G – lead-free, RoHS6

1. Description

The power modules are DC-DC converters in an industry 1/2 brick packaging and footprint, and can provide up to 12V_{DC} output voltage and 8.3A output current. The modules are packed in a molded package with Aluminum baseplate, all the devices on the module are surface mounted, and the power devices are mounted on the Aluminum baseplate. The power modules feature high power density, remote on/off, over-temperature protection and current limit, etc.

2. Technical Specifications (Unless otherwise stated, all specifications are typical at nominal input voltage, full load, 25 ℃)

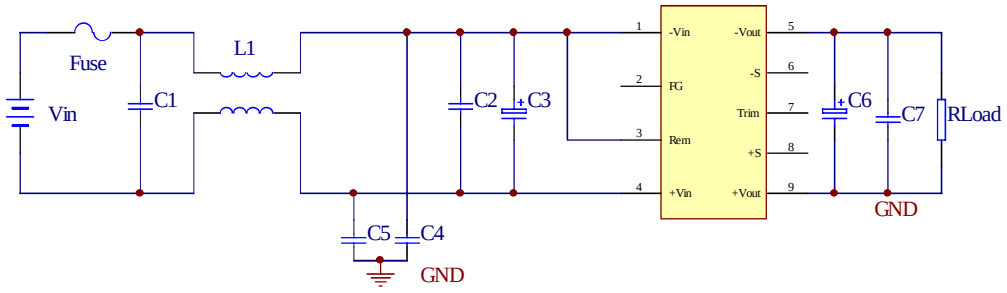
Parameter		Test Condition	Min	Typ	Max	Unit
2.1 Absolute Maximum Ratings						
Input Voltage (Vi)		Non-operating, continuous	0	—	80	Vdc
Input Transient Voltage (Vit)		100ms, Not repeat	—	—	100	Vdc
Max Output Power (Pomax)		allowable operating conditions	—	—	100	W
2.2 Input Specifications						
Typical Input Voltage(Vinom)		—	—	48	—	Vdc
Input Voltage Range		—	36	—	75	Vdc
Input Under-voltage Protection (Vishl)		Ionom	30	—	35	Vdc
Input Under-voltage Recovery Point		Ionom	31	—	36	Vdc
Max Input Current (Iimax)		Vimin, Vonom,Ionom	—	—	3.4	A
No-load Input Current (Iio)		Vinom, Io＝0A	—	—	100	mA
Quiescent Input Current (Iiof)		Vinom, remote output shutdown	—	—	20	mA
Remote on/off (Negative Logic)	On	Low level(≤1.2V) or connected to -Vin, control current ≤ 2mA				
	Off	High level (3~15V) or Open Circuit, control current ≤ 2mA				
2.3 Output Specifications						
Output Voltage Set-point Precision(Vonom)		Vinom,Ionom	11.88	12.00	12.12	Vdc
Typical Load(Ionom)		—	—	—	8.3	A
Output Current Range (Io)		Po≤100W	0	—	8.3	A
Line Regulation (Vov)		Vimin-Vimax,Ionom	—	—	±0.2	%Vo
Load Regulation (Vol)		0-100%Ionom,Vinom	—	—	±0.5	%Vo
Output Voltage Trim Range		Io≤Ionom,Po≤100W	-10	—	+10	%Vo
Output Over-voltage Protection Mode		Po<Pomax	Shutdown output, lock (re-power to recovery)			
Output Over-voltage Protection		Po<Pomax	13.2		16.8	Vdc

Parameter		Test Condition	Min	Typ	Max	Unit
Output Over-current Protection	Protection Mode	——		Hiccp		—
	Threshold	Vinmin~Vinmax, Tc (baseplate temp.)=-40~100℃	8.72		12.45	A
Output Short-circuit Protection	Protection Mode	——		Hiccup, Auto-recovery		—
Dynamic Load Response	Peak Deviation	25%-50%-25%Ionom 50%-75%-50%Ionom ΔIo/Δt=0.1A/μS, Vinom	—	—	600	mV
	Settling Time		—	—	200	μs
Output Ripple and Noise		20MHz , externally add a 0.1μF/25V ceramic capacitor and a 10μF tantalum capacitor to output	—	—	250	mV
External Output Capacitance (Co)		Electric load at CR or pure resistive load	0	—	10000	μF
Turn-on/off Peak Deviation		Vinom,Ionom	—	—	±5	%Vo
Turn-on Delay Time		90%Vinnom-- 10%Vonom	0	—	35	mS
Turn-on Rise Time		10%Vonom---90%Vonom	0	—	35	mS
2.4 Safety Specifications						
Isolation voltage	Input to output	Leak Current≤1mA, 1min	1500	—	—	Vdc
	Input to Case	Leak Current≤1mA, 1min	1050			Vdc
	Output to Case	Leak Current≤1mA, 1min	500			Vdc
Isolation Resistance (RISO)		—	50	—	—	MΩ
Safety Certificate		IEC60950/EN60950/UL60950				
2.5 Reliability						
Vibration Test(sine)		Frequency: 10~55Hz Amplitude: 0.35mm Acceleration: 50m/s2 Cycle: X,Y,Z 30min each axis	After being tested, no damage to the converter and its components, the appearance, output voltage and output ripple and noise (p-p) meet the data sheet requirements.			
Impact Test (half-sine)		Peak Acceleration: 300m/s2 Duration: 6ms 6 times for three perpendicular directions	After being tested, no damage to the converter and its components, the appearance, output voltage and output ripple and noise (p-p) meet the data sheet requirements.			
MTBF		2×106h (Bellcore TR332,Tc=40℃)				
2.6 Environmental Specifications						
Relative Humidity		(40±2) ℃, No dew	—	—	90	%RH
Cooling		——	Conduction Cooling			
Operating Baseplate Temperature		See the Derating Curve	-40	—	+100	℃
Over-temperature protection		——	100～125℃(Auto-recovery)			

Parameter	Test Condition	Min	Typ	Max	Unit
Storage Temperature (Tst)	Non-operating	-55	—	+125	℃
2.7 General Specifications					
Switching Frequency	——	—	300	—	k Hz
Temperature Coefficient (Tcoeff)	——	—	—	±0.02	%/℃
Efficiency (η)	Vinom,Ionom	86	90	—	%
RoHS	2002/95/EC directive				
Anti-sulfuration feature	Sprayed conformal coating				

3. Basic Application Circuit and Considerations

3.1 Typical Application



Note: Fuse -10A C3 ≥47μF/100V C7-1μF/25V C6 - 1000μF /25V
With EMC requirements: C1 - 1μF /100V; C2 - 0.1μF /100V;
L1 - Common-mode Inductor (Single phase) 1.32mH±25%;
C4, C5: 22nF/1500V;

3.2 Input Voltage up to 80Vdc for long time or reverse input polarity would cause the module damaged.

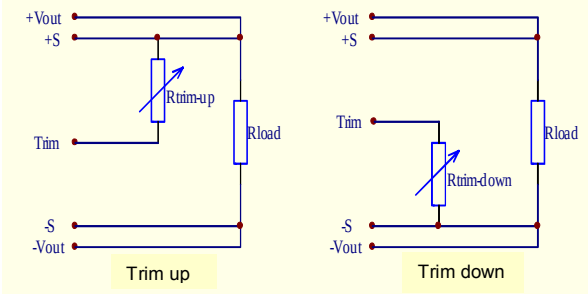
3.3 Output will be on when the Rem is at low level or connected to –Vin; Output will be off when the Rem is at high level or when the Rem keeps open circuit referenced to –Vin.

3.4 Output short-current protection mode is hiccup, automatic recovery. But it is not recommend to keep the module operate in this state for long time.

3.5 Output Trim: Exceed the maximum output power (trim up) or the maximum output current (trim down) may cause the converter operates abnormally. The output voltage shall not exceed 13.2V (trim up) or be lower than 10.8V (trim down), or the converter can't work well. See "4. Output Voltage Adjustment (Trim)" for details.

4 Output Voltage Adjustment (Trim)

4.1 Output Trim Circuit



4.2 Output Trim Equations

(1) To increase the output voltage, the value of the external resistor should be

$$R_{Trim-up} = \left(\frac{Vo(100+\Delta)}{1.26\times\Delta} - \frac{(100+2\Delta)}{\Delta} \right) (k\Omega) \qquad 0<\Delta<10$$

(2) To decrease the output voltage, the value of the external resistor should be

$$R_{Trim-down} = \left(\frac{100}{\Delta} - 2 \right) (k\Omega) \qquad 0<\Delta<10$$

Where V_O is rated output voltage;

$R_{Trim-up}$、$R_{Trim-down}$ are external adjusting resistors;

$\Delta(\%)$: Ratio of output voltage changes to nominal output voltage

5 Characteristic Curves

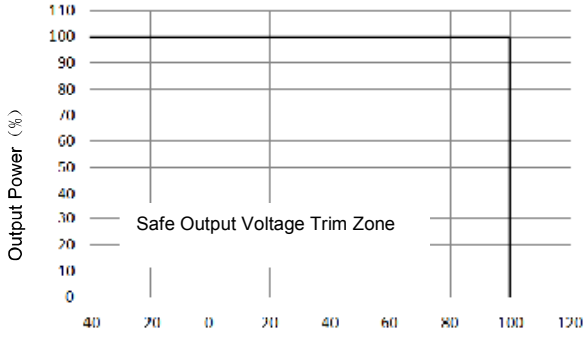


Figure 1. Output Power vs Baseplate temperature

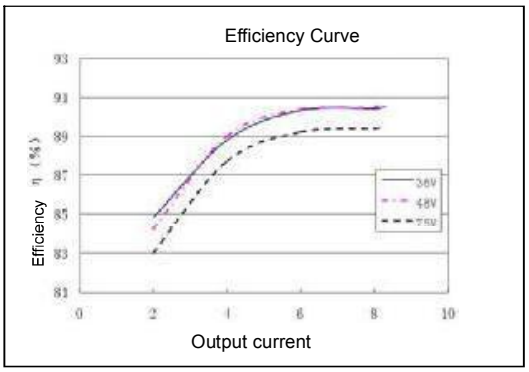


Figure 2 Output Current vs Efficiency (Ta＝＋25℃)

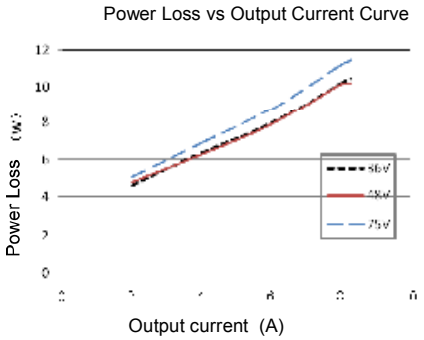


Figure 3. Power Loss vs Output Current

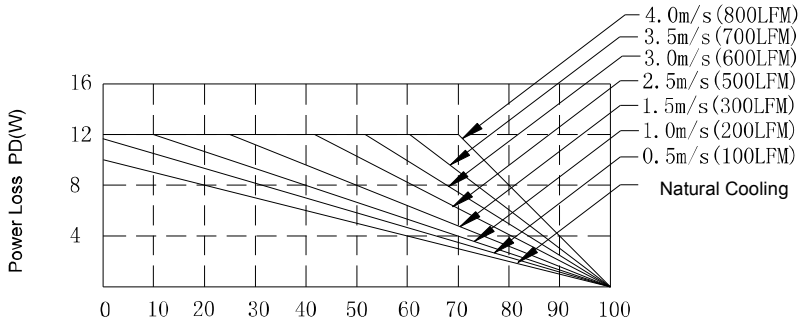


Figure 4 Derating Curves with no heat sink at different airflow

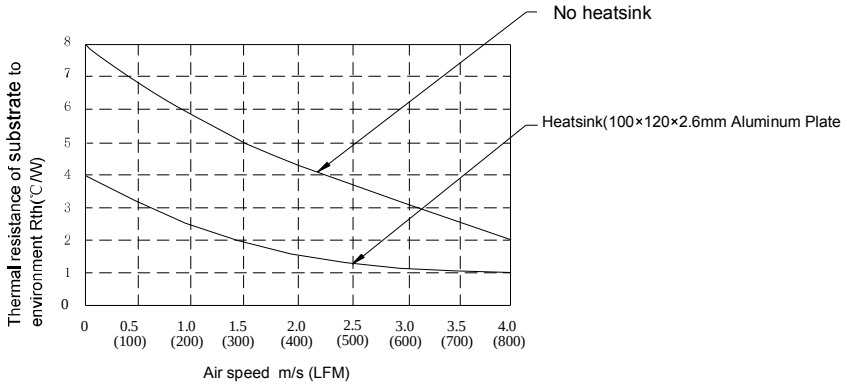


Figure 5 Thermal resistance of substrate to environment VS Air Speed

6 Thermal Considerations

The power modules operate in a changing temperature environment, the power module itself has a certain power conversion efficiency so that the power module will produce heat, especially when output a large power (even up to tens of watts). These losses produce a temperature difference between the power module case and the surrounding environment, namely the power module's temperature rise.

In order to ensure the power modules's reliability at long-time operation, it needs to make the case temperature (or baseplate temperature) keep within the specified specification. In particular, due to the limited heat exchanging area of the modules with high thermal dissipation, it is required to add heat sinks or forced-air cooling to reduce the thermal resistance of the module and the surrounding environment, decrease the module's case temperature using heat conduction, convection and radiation, so as to ensure the module's reliability at long-term and continuous operation.

Thermal design shall follow the following steps:

1) Determine the maximum actual output power Po, the maximum ambient temperature Ta and the expected maximum case temperature Tc;

Use the parameters above to calculate the temperature rise △T:

△T＝Tc—Ta

Note: Tc shall be kept within range specified in the technical specifications book.

2) Calculate the module's power Loss Pd:

$$P_D = \frac{1-\eta}{\eta} \times Po$$

η—Conversion Efficiency

Po—Output Power

3) Calculate the necessary thermal resistance Rth. Tow mode: heat sink and force-air cooling (no heat sink):

a) Selection of a heat sink

i. The required thermal resistance of heat sink : Rth=△T / PD

ii. According to the Rth above and the module's dimensions, select a heat sink of which the thermal resistance is less than the Rth above.

b) Selection of forced-air cooling

i. Calculate the module case's thermal resistance to surrounding air: Rth=△T / PD

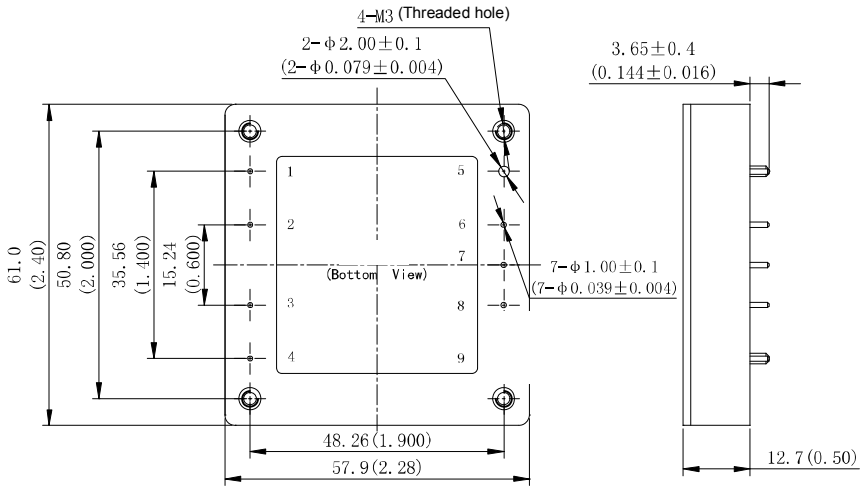
ii. According to the Rth above and Figure 5 – "Thermal resistance of substrate to environment VS Air Speed", select the corresponding air speed value. It is required to consider the derating curve when determining the air speed in actual thermal design.

3) Test & Verification

Use the actual operation data to test the accuracy of the calculated values above, and revise them.

7 Dimensions and Pin definition

7.1 Dimensions



(1) .X±0.5 (.XX±0.02) .XX±0.25 (.XXX±0.010)
(2) Unit mm (inch)

7.2 Pin Definition

No	1	2	3	4	5	6	7	8	9
Symbol	-Vin	FG	Rem	+Vin	-Vout	-S	Trim	+ S	+Vout
Definition	Negative input	FG	Remote	Positive input	Negative output	Negative Remote Sense	Trim	Positive Remote Sense	Positive output